

AMENDMENTS TO THE CLAIMS

1. (Currently amended) A dielectric resonator device comprising:
a circuit substrate having a ground electrode and a transmission line; ~~and~~
a dielectric resonator ~~which is~~ attached to the circuit substrate at a position
facing the ground electrode and ~~[[is]]~~ coupled to the transmission line, the dielectric
resonator including a dielectric substrate and electrodes disposed on opposite surfaces
of the dielectric substrate, the electrodes respectively having openings that face each
other~~[[,]]~~;

~~wherein~~ an insulating layer ~~is provided~~ located between the ground electrode
of the circuit substrate and the electrodes of the dielectric resonator so as to insulate the
ground electrode from the electrodes~~[[,]]~~; and ~~wherein one of the openings of the~~
~~dielectric resonator is provided with~~

an insulative adhesive provided at one of the openings of the electrodes of
the dielectric resonator for joining the dielectric resonator to the circuit substrate.

2. (Currently amended) The dielectric resonator device according to Claim 1,
wherein the insulating layer surrounds ~~said~~ the one of the openings of the dielectric
resonator.

3. (Currently amended) The dielectric resonator device according to Claim 2,
wherein the insulating layer is provided with a relief passage for guiding the insulative
adhesive outward from ~~said~~ the one of the openings of the dielectric resonator.

4. (Currently amended) An oscillator comprising the dielectric resonator
device according to Claim 1 ~~any one of Claims 1 to 3~~.

5. (Currently amended) A transmitter-receiver apparatus comprising the dielectric resonator device according to Claim 1 ~~any one of Claims 1 to 3~~.

6. (New) A dielectric resonator device comprising:

a circuit substrate having a ground electrode and a transmission line;

a dielectric resonator attached to the circuit substrate at a position facing the ground electrode and coupled to the transmission line, the dielectric resonator including a dielectric substrate and electrodes disposed on opposite surfaces of the dielectric substrate;

an insulating layer located between the ground electrode of the circuit substrate and one of the electrodes of the dielectric resonator; and

an insulative adhesive provided between the dielectric resonator and the circuit substrate for joining the dielectric resonator to the circuit substrate.

7. (New) The dielectric resonator device according to Claim 6, wherein the electrodes of the dielectric resonator respectively having openings that face each other, and the insulating layer surrounds one of the openings.

8. (New) The dielectric resonator device according to Claim 7, wherein the insulating layer is provided with a relief passage for guiding the insulative adhesive outward from the one of the openings of the electrodes of the dielectric resonator.

9. (New) An oscillator comprising the dielectric resonator device according to Claim 6.

10. (New) A transmitter-receiver apparatus comprising the dielectric resonator device according to Claim 6.